PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Richard S. Graf	12/16/2010
Keishi Okamoto	12/17/2010
Faraydon Pakbaz	12/17/2010
Jack R. Smith	12/15/2010
Sebastian T. Ventrone	12/15/2010

RECEIVING PARTY DATA

Name:	International Business Machines Corporation
Street Address:	New Orchard Rd.
City:	Armonk
State/Country:	NEW YORK
Postal Code:	10504

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12984638

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NAME OF SUBMITTER: Frederick W. Gibb, III

PATENT

REEL: 025583 FRAME: 0852

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Total Attachments: 4

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> PATENT REEL: 025583 FRAME: 0853

ASSIGNMENT

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") in:

Title of the Invention: INTEGRATED CIRCUIT CHIP INCORPORATING EMBEDDED
THERMAL RADIATORS FOR LOCALIZED, ON-DEMAND, HEATING AND A SYSTEM AND
METHOD FOR DESIGNING SUCH AN INTEGRATED CIRCUIT CHIP

<u>•</u>	mber provided above in the header of this Assignment, for ent was executed concurrently herewith or was filed having:
Serial Number:	(insert series code and serial number here if/when available)
business at Armonk, New York (herein refer	orporation, a corporation of New York having a place of red to as "IBM"), desires to acquire, and each undersigned vorldwide right, title, and interest in and to the Invention and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned Inventor ("ASSIGNOR") hereby sells, assigns, and otherwise transfers to IBM (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in IBM, its successors, legal representatives, and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

Each undersigned Inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to IBM and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned Inventor also hereby grants IBM, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent application Serial Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

[Inventor Signature Page(s) Follows]

		Executed by Inventor 1
Signature:	Richard S. Graf	Date: 12/16/2010
		Executed by Inventor 2
Signature:	Keishi Okamoto	Date:
		Executed by Inventor 3
Signature:	Faraydon Pakbaz	Date:
		Executed by Inventor 4
Signature:	Jack R. Smith	Date:
) j	Executed by Inventor 5
Signature:	Schastian T. Ventra	Date:

Page 2 of 2

PATENT REEL: 025583 FRAME: 0855

Executed by Inventor 1	
Signature: _	Richard S. Graf
	Richard S. Graf
	Executed by Inventor 2
Signature:	Keishi Chamoto Date: 17. Dec. 2010
organizato.	Keishi Okamoto
	Executed by Inventor 3
Signature:	
	Faraydon Pakbaz
	Executed by Inventor 4
Signature:	Date:
	Jack R. Smith
	Executed by Inventor 5
Signature:	Date:
Drawta.	Sebastian T. Ventrone

Page 2 of 2

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	Executed by Inventor 1
Signature:	Pate: Date:
	Executed by Inventor 2
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	Executed by Inventor 3
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	Executed by Inventor 4
Signature:	Jack R. Smith Date: 12/15/20/0
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Page 2 of 2

RECORDED: 01/05/2011

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